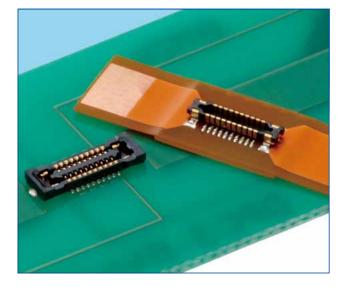
NEW

0.35mm Pitch 0.8mm Height Hybrid Power/Signal Connectors for Board-to-Board and FPC-to-Board

BM24 Series



Features

1. Rated current : 5A

The compact BM24 Series features a space-saving design with the power contacts rated at 5A, and the signal contact rated at 0.25A. (Fig.1)

2. High contact reliability

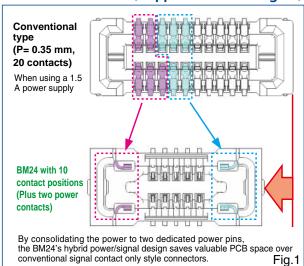
A 2-point contact structure for both power and signal contacts provides high contact reliability. (Fig.3)

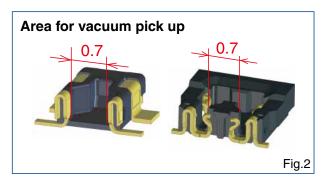
3. Enhanced mating process

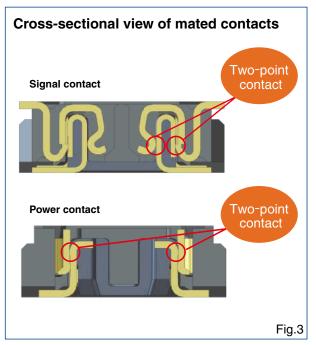
A guide rib ensures self-alignment during mating, with an alignment range of 0.3mm. In addition, a tactile click is generated upon mating completion, preventing incomplete mating and enhancing mating operability.

4. Supports USB3.0/3.1 transmission

The signal contact supports USB3.0/3.1 signals.







(Supports USB3.0 signal)

Product Specifications

Potingo	Rated current	Power contact : 5A Signal contact : 0.25 A(Note 1)	Operating temperature range	-40 to 85°C (Note 2)	Storage temperature range	-10 to 60℃ (Note 3)
Ratings	Rated voltage	30V AC/DC	Operating humidity range	20 to 80%	Storage humidity range	40 to 70% (Note 3)

Items	Specifications	Conditions
1. Insulation resistance	Minimum of 100MΩ	Measured at 100V DC
2. Withstanding voltage	No flashover or dielectric breakdown	150V AC for one minute
3. Contact resistance	Signal contact : $100m\Omega$ max. Power contact : $15m\Omega$ max.	Measured at 20mV AC, 1kHz, and 1mA
4. Vibration	No electrical discontinuity for more than 1μ s.	Frequency : 10 to 55 Hz ; half amplitude : 0.75mm, in 3 axis directions for 2 hours
5. Humidity	$\begin{array}{l} Contact\ resistance: Signal\ contact:\ 100m\Omega\ max.\\ Power\ contact:\ 15m\Omega\ max.\\ Insulation\ resistance:\ 50M\Omega\ min. \end{array}$	96 hours at a temperature of 40 $\pm 2^\circ\!\!C$ and a humidity range from 90 to 95%
6. Temperature cycle	$\begin{array}{l} Contact\ resistance: Signal\ contact:\ 100m\Omega\ max.\\ Power\ contact:\ 15m\Omega\ max.\\ Insulation\ resistance:\ 100M\Omega\ min. \end{array}$	(-55 [°] C for 30 minutes → 5 to 35 [°] C for 10 minutes → 85 [°] C for 30 minutes → 5 to 35 [°] C for 10 minutes) in 5 cycles
7. Durability	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $15m\Omega$ max.	10 mating cycles
8. Solder heat resistance	No dissolution or melting of the resin that will affect the performance.	Reflow : with recommended temperature profile ; Hand soldering at soldering iron temperature of 350°C for 3 seconds max.

Note 1 : The total current capacity for connectors with 40 or more signal contacts is 10A for all contacts.

Note 2 : Includes temperature rise caused by current flow.

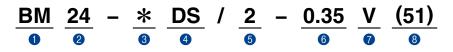
Note 3 : Storage refers to long-term-storage of unused items before they are mounted on the PCB. Operating temperature / humidity range applies to the state of temporary storage such as non-powered after mounting on the PCB, and during transportation, etc.

Materials

Product	Part	Materials Finish		UL Regulation
	Insulator	LCP	Black	UL94V-0
Receptacle Header	Signal contact	Phosphor bronze	Gold plated	
	Power contact	Copper alloy	Gold plated	

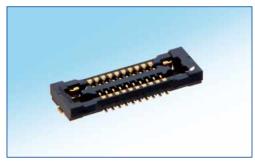
Product Number Structure

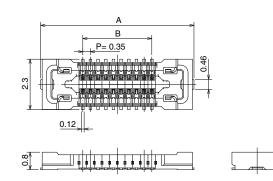
Receptacle / Header



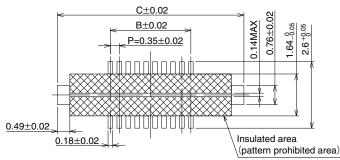
1 Series Name : BM	5 Number of Power Contacts : 2	
2 Series No. : 24	6 Contact Pitch : 0.35mm	
3 Number of Signal Contacts : 10, 20, 24, 30, 40	 Termination type V : Straight SMT 	
Connector type DS : Receptacle	 Gold plated specification and packaging status (51) : Gold plate thickness 0.05µm 	
DP : Header	Embossed tape packaging (10,000 pcs/reel)	

Receptacle

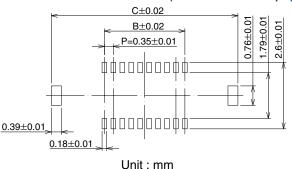




Recommended PCB layout



Recommended metal mask dimensions (mask thickness : 100 µm)

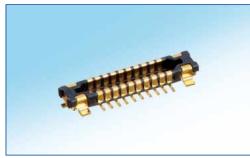


				0	
Part No.	HRS No.	No. of Contacts	A	В	С
BM24-10DS/2-0.35V(51)	677-2002-1 51	10	5.25	1.4	5.55
BM24-20DS/2-0.35V(51)	677-2004-7 51	20	7	3.15	7.3
BM24-24DS/2-0.35V(51)	677-2006-2 51	24	7.7	3.85	8
BM24-30DS/2-0.35V(51)	677-2008-8 51	30	8.75	4.9	9.05
BM24-40DS/2-0.35V(51)	677-2010-0 51	40	10.5	6.65	10.8

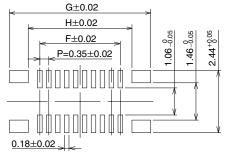
Note 1 : Please place orders in full reel quantities.

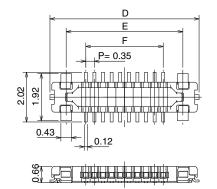
Note 2 : This connector has no polarity.

Header



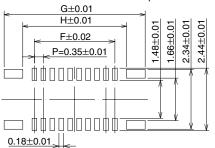
Recommended PCB layout







Recommended metal mask dimensions (mask thickness : 100 µm)



Unit : mm

Part No.	HRS No.	No. of Contacts	D	E	F	G	Н
BM24-10DP/2-0.35V(51)	677-2001-9 51	10	4.32	3	1.4	3.77	2.31
BM24-20DP/2-0.35V(51)	677-2003-4 51	20	6.07	4.75	3.15	5.52	4.06
BM24-24DP/2-0.35V(51)	677-2005-0 51	24	6.77	5.45	3.85	6.22	4.76
BM24-30DP/2-0.35V(51)	677-2007-5 51	30	7.82	6.5	4.9	7.27	5.81
BM24-40DP/2-0.35V(51)	677-2009-0 51	40	9.57	8.25	6.65	9.02	7.56

Note 1 : Please place orders in full reel quantities.

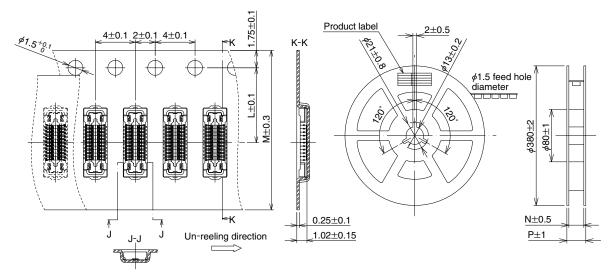
Note 2 : This connector has no polarity.



Embossed Tape Dimensions (complies with JIS C 0806)

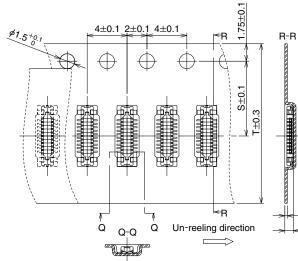
Receptacle

Reel dimensions

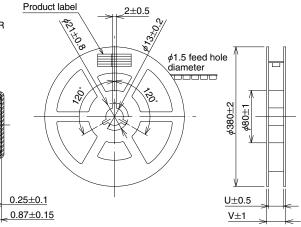


					Unit : mm
Part No.	No. of Contacts	L	М	N	Р
BM24-10DS/2-0.35V(51)	10				
BM24-20DS/2-0.35V(51)	20	7.5	16	17.5	21.5
BM24-24DS/2-0.35V(51)	24				
BM24-30DS/2-0.35V(51)	30	11.5	24	25.5	20 F
BM24-40DS/2-0.35V(51)	40	11.5	24	20.5	29.5

Header



•Reel dimensions



					Unit : mm
Part No.	No. of Contacts	S	Т	U	V
BM24-10DP/2-0.35V(51)	10				
BM24-20DP/2-0.35V(51)	20	7.5	16	17.5	21.5
BM24-24DP/2-0.35V(51)	24				
BM24-30DP/2-0.35V(51)	30	44 5	04	05.5	29.5
BM24-40DP/2-0.35V(51)	40	11.5	24	25.5	29.5

BM24 Series 0.35mm Pitch 0.8mm Height Hybrid Power/Signal Connectors for Board-to-Board and FPC-to-Board

Precautions

1.Recommended solder temperature profile	250		
	20 20 20 10 10 10 10 10 10 10 10 10 1		
2. Recommended manual soldering conditions	Please contact us if the concentration is below 1,000 ppm.Soldering iron temperature: $340 \pm 10^{\circ}$ C ;Soldering time: within 3 seconds		
3. Recommended stencil thickness and open area ratio to PCB pattern area	Thickness: 0.1 mm Aperture ratio : 80% on the DS side ; 70% on the DP side		
4. Board warpage	A maximum of 0.02 mm at the center of the connector relative to each end of the connector.		
5. Cleaning conditions	Cleaning is not recommended. If you clean this product, please evaluate its performance before using it. (Cleaning may impair the mating/unmating properties and lower resistance to environmental factors)		
6. Precautions	 Care should be taken when mating/unmating the connector when it is not mounted on the PCB. This could cause damage or deformation of the contacts. Avoid supporting the PCB only with the connectors. Support it by other means such as bolts, screws, posts, etc. Care should be taken that excessive prying mating/unmating could cause damage. In the case of hand soldering, please do not apply any flux, which could cause flux wicking. This product may have slight color differences due to production lot variability, but this does not the performance. Please refer to the next page for precautions regarding mating/unmating. Because the product can disengage if dropped (or other impact), and by FPC routing, it is advised to secure the mated connectors to the board with housings and cushioning materials. 		

Handling Precautions when Mating Connectors

BM24-*DS-0.35V	
	Do not apply excessive force while positioning the connector for mating. Too much force will cause damage/shaving of the housing material, and may lead to a failure in contact resistance and other issues.
	Once the positioning for correct mating is obtained, mating height drops down one stage. There is no movement in the horizontal direction. Mating should occur at this stage, while taking care that there is no horizontal movement.

•Handling Precautions when Un-mating Connectors

BM24-*DS-0.35V BM24-*DP-0.35V	
	Be sure to unmate the connectors in a straight line direction.
Pitch orientation Correct	If you are unable to unmate a cnnector in straight line direction due to a handling issue, pull it out in an oblique direction as shown in the figure on the left. However, the connector could be broken if there is not enough support on the FPC. Please account for this during prototyping.
Corner orientation Incorrect	Unmating a connector by a corner, as shown in the figure to the left, could damage the connector and contacts. Never disconnect connectors using a corner.
	Make sure that the FPC has a stiffener of sufficient strength. If the stiffener is not strong enough, the connector could be broken, as shown in the figure on the left. It is advised to test the FPCs strength by repeated mating/unmating cycles. We recommend the use of a glass epoxy material with a minimum thickness of 0.3 mm, or a stainless steel material with a minimum thickness of 0.2 mm.



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The characteristics and the specifications contained herein are for reference purpose. Please refer to the latest customer drawings prior to use. The contents of this catalog are current as of date of 07/2015. Contents are subject to change without notice for the purpose of improvements.